

DATA SHEET

CURRENT SENSOR - LOW TCR AUTOMOTIVE GRADE

PA1206_L series 5%, 1%

RoHS compliant & Halogen free



YAGEO





Chip Resistor Surface Mount

SERIES PA1206 L

SC<u>ope</u>

This specification describes PA1206 series chip resistors with RoHS compliant.

<u>APPLICATIONS</u>

- · Power supplies
- Consumer(Mobile, PNDs)
- Laptop
- HDDs
- Automotive

FEATURES

- AEC-Q200 qualified
- Total lead free without RoHS exemption
- Halogen-free Epoxy
- RoHS compliant
- Reduce environmentally hazardous wastes
- · High component and equipment reliability
- · Non-forbidden materials used in products/production
- · Low resistances applied to current sensing
- · Low thermal EMF
- Moisture sensitivity level: MSLI

ORDERING INFORMATION - GLOBAL PART NUMBER

Global part numbers are identified by the series, size, tolerance, packing type, temperature coefficient, taping reel and resistance value.

GLOBAL PART NUMBER

PA XXXX X X X XX XXXX L

(2) (3) (4) (7)

(I) SIZE

1206

(2) TOLERANCE

 $F = \pm 1\%$

 $| = \pm 5\%$

(3) PACKAGING TYPE

K = Embossed taping reel

(4) TEMPERATURE COEFFICIENT OF RESISTANCE

 $L = \pm 150 ppm/^{\circ}C$

(5) TAPING REEL

07 = 7 inch dia. Reel & standard power (1/4W)

7W = 7 inch dia. Reel & 2 x standard power (1/2W)

47 = 7 inch dia. Reel & $4 \times$ standard power (IW)

67 = 7 inch dia. Reel & $6 \times standard$ power (1.5W)

(6) RESISTANCE VALUE

0U5(0.5mR) and 0U6(0.6mR)

(7) DEFAULT CODE

Letter L is the system default code for ordering only. (Note)

ORDERING EXAMPLE

The ordering code of a PA1206 1/2W chip resistor, TC150, value 0.0005Ω with $\pm1\%$ tolerance, supplied in 7-inch tape reel with 2Kpcs quantify is: PA1206FKL7W0U5L

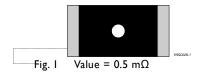
NOTE

- I. All our RChip products are RoHS compliant and Halogen Free. "LFP" of the internal 2D reel label mentions "Lead-Free Process"
- 2. On customized label, "LPF" or specific symbol can be printed.



MARKING

PA1206



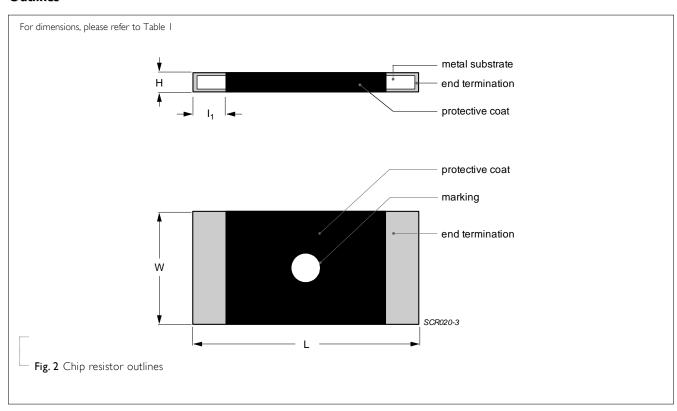
I digit For PA1206 $0.5 m\Omega$ and $0.6 m\Omega$

CONSTRUCTION

The composition of the resistive material is adjusted to give the approximate required resistance and is covered with a protective coat.

Finally, the three materials of external terminations (Cu / Ni / matte Tin) are added, as shown in Fig. 2.

Outlines





DIMENSION

Table I For outlines, please refer to Fig. 2

TYPE	L (mm)	W (mm)	H (mm)	lı (mm)
PA1206	3.20 ± 0.25	1.60±0.25	1.15±0.25	0.73±0.25

Note:

- 1. For relevant physical dimensions, please refer to construction outlines.
- 2. Please contact with sales offices, distributors and representatives in your region before ordering.

ELECTRICAL CHARACTERISTICS

Table 2

TEMPERATURE COEFFICIENT OF RESISTANCE ⁽³⁾	resistance range	TOLERANCE ⁽²⁾	POWER RATING ⁽⁴⁾	SIZE	SERIES
150ppm/°C (L)	0.5m $\Omega/$ 0.6m Ω	±1% (F)	1/4W (07) 1/2W (7W)	1206	PA
		±5% (J)	IW (47) I.5W (67)		

Note: I. Please contact with sales offices, distributors and representatives in your region before ordering.

- 2. Global part number (code7)
- 3. Global part number (code 9)
- 4. Global part number (code 10-11)

FUNCTIONAL DESCRIPTION

OPERATING TEMPERATURE RANGE

PA1206 Range: -55°C to +170°C

POWER RATING

Standard rated power at 70°C:

For detail power value, please refer to Table 2.

RATED VOLTAGE

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

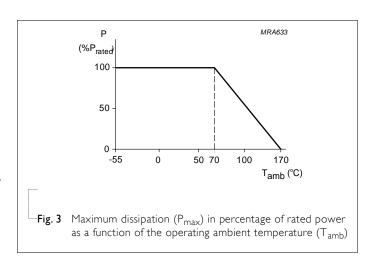
$$V = \sqrt{(PxR)}$$

Where

V = Continuous rated DC or AC (rms) working voltage (V)

P = Rated power (W)

 $R = Resistance value (\Omega)$





PACKING STYLE AND PACKAGING QUANTITY

Table 3 Packing style and packaging quantity

PACKING STYLE	REEL DIMENSION	PA I 206
Embossed taping reel (k)	7" (178 mm)	2,000

EMBOSSED TAPE

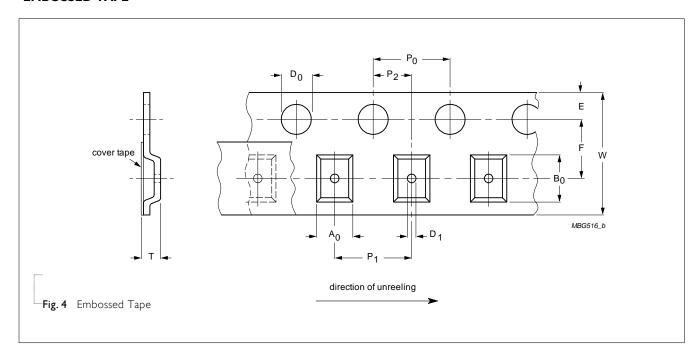
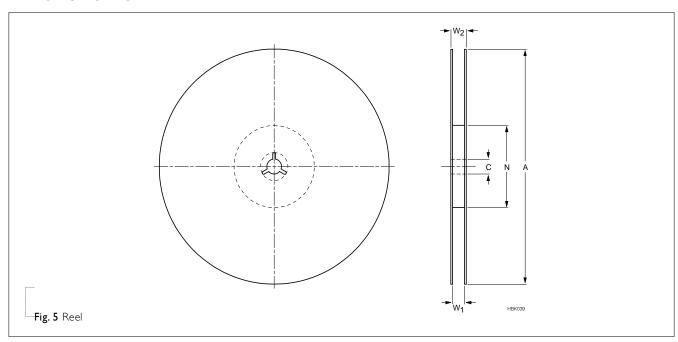


Table 4 Dimensions of paper tape for relevant chip resistors size

SIZE	SYMBOL										Unit: mm
	A_0	B ₀	W	E	F	P ₀	Pı	P ₂	ØD₀	ØDı	Т
PA 1206	5 1.95± 0.10	3.50± 0.10	8.00± 0.20	1.75± 0.10	3.50± 0.05	4.00±0.05	4.00±0.10	2.00±0.05	1.50+0.10	1.00±0.10	1.74± 0.10



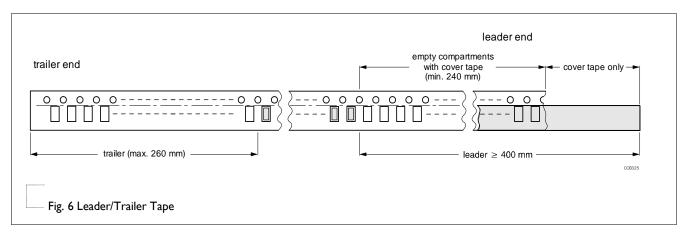
REEL SPECIFICATION



-Table 5 Dimensions of reel specification for relevant chip resistors size

	QUANTITY — PER REEL	REEL SIZE		SYMBOL					Unit: mm
SIZE		8 mm TAPE WIDE	I2 mm TAPE WIDE	Α	N	С	D	Wı	W _{2 MAX.}
PA1206	2000	7" (Ø178 mm)		180.0+0/-3	60.0+1/-0	13.0± 0.2	21.0±0.8	8.4 +1/-0	12.4

LEADER/TRAILER TAPE SPECIFICATION



FOOTPRINT AND SOLDERING PROFILES

For recommended soldering profiles, please refer to data sheet "Chip resistors mounting".

FOOTPRINT

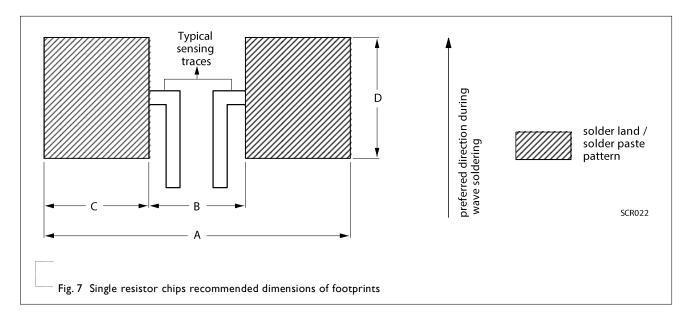


Table 6 Footprint dimensions

				Unit: mm
SIZE	Α	В	С	D
PA I 206	4.20	0.90	1.65	2.18



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TESTS AND REQUIREMENTS

Table 7 Test condition, procedure and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENT
Short time	IEC60115-1 4.13	5 times of rated power for 5 seconds at	$\pm 0.5\% + 0.0005 \Omega$
overload		room temperature	No visible damage
High Temperature Exposure	MIL-STD-202-Method 108	I,000 hours at maximum operating temperature depending on specification, unpowered	±1.0%+0.0005 Ω
		No direct impingement of forced air to the parts Tolerances: I70±3°C	
Temperature Cycling	JESD22-A104C	I,000 cycles, -55/+125°C for I cycle per hour	±1.0%+0.0005 Ω
Moisture Resistance	MIL-STD-202-Method 106	Each temperature / humidity cycle is defined at 8 hours method 106F, 3 cycles / 24 hours for 10d with 25°C / 65°C 95% R.H, without steps 7a & 7b, unpowered	±0.5%+0.0005 Ω
Biased	MIL-STD-202 Method 103	1,000 hours; 85°C / 85% RH	±1.0%+0.0005 Ω
Humidity		10% of operating power	
Operational Life/ Endurance	MIL-STD-202-Method 108 IEC 60115-1 4.25.1	I,000 hours at 125±3°C, applied de-rated power 1.5 hours on, 0.5 hour off, still-air required	±1.0%+0.0005 Ω
		1,000 hours at 70±2°C applied rated power 1.5 hours on, 0.5 hour off, still air required	±1.0%+0.0005Ω
Resistance to Solvents	MIL-STD-202 Method 215	Immerse in isopropyl alcohol for 5 min with ultrasonic at room temperature	No Visible damage
Mechanical Shock	MIL-STD-202 Method 213	Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen.	±0.5%+0.0005 Ω
		Peak value: 100 g's	
		Duration: 6 ms	
		Velocity change: 12.3 ft/s	
		Waveform: Half sine	
Vibration	MIL-STD-202 Method 204	5 g's for 20 min., 12 cycles each of 3 orientations	±0.5%+0.0005Ω
		Test from 10-2000 Hz.	
Resistance to Soldering Heat	IEC60115-14.18 & IEC60068-2-58	Specimen passed 3 times reflow temperature at 260+0/-5°C, with solder	$\pm 0.5\% + 0.0005 \Omega$ No visible damage
Thermal Shock	MIL-STD-202 Method 107	-55/+125°C, Number of cycles is 300.	±0.5%+0.0005Ω
		Devices mounted.	No visible damage
		Maximum transfer time is 20 seconds.	
		Dwell time is 15 minutes, Air -Air	





TEST TEST METHOD PROCEDURE REQUIREMENT Electrostatic AEC-Q200-002 Human Body Model, I pos + I neg. $\pm 1.0\% + 0.0005 \Omega$ Discharge No visible damage Discharges 1206=2KV Solderability IPC/JEDEC J-STD-002 (a) Baking 4 hours at 155°C dry heat, Well tinned - Wetting dipping at 235±3°C for 5±0.5 seconds. (>95% covered) No visible damage (b) Steam aging 8 hours, dipping at 215±3°C for 5±0.5 seconds. (c) Steam aging 8 hours, dipping at 260±3 °C for 30±0.5 seconds. **Flammability** UL94 No ignition of specimen; Try to inflame a specimen by a needle V-0 flame Board Flex / $\pm 1.0\% + 0.0005 \Omega$ AEC-Q200-005 Chips mounted on a 90mm glass epoxy Bending resin PCB FR4, Bending for 1206=2 mm Holding time: Min.60 seconds **Terminal** $\pm 1.0\% + 0.0005 \Omega$ AEC-Q200-006 Applied a 17.7N 1.8Kg for 60±1 seconds. Strength SMD No visible damage Flame Retardance No flame. AEC-Q200-001 Only requested, when voltage/power will increase the surface temp to 350°C no explosion Temperature MIL-STD-202 Method 304 Refer to table 2 At +25/+150°C Coefficient of Resistance T.C.R. Formula: $\text{T.C.R=} \ \frac{R_{\scriptscriptstyle 2} - R_{\scriptscriptstyle 1}}{R I(t_{\scriptscriptstyle 2} - t_{\scriptscriptstyle 1})} \ \times \text{IO-ppm/°C}$ Where t1=+25°C or specified room temperature t2=+150°C test temperature RI=resistance at reference temperature in R2=resistance at test temperature in ohms Flower-of-Sulfur Modified ASTM B809-95 Sulfur 105°C, 750 hours, unpowered. $\pm 1.0\% + 0.0005 \Omega$ FOS





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REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 0	Apr. 26, 2021	-	- New datasheet for automotive grade current sensor – PA I 206_L $0.5 m\Omega$ & $0.6 m\Omega$.

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Chip Resistor Surface Mount

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